

SMD Power Inductor NR - 252012-Series (Alloy)



Features & Application

2020/1/1

- Metallization on Alloy core results in excellent shock resistance and damage-free durability.
- Closed magnetic circuit design reduces leakage flux and Electro Magnetic Interference (EMI).
- Fe base metal material core provides large saturation current.
- Automatic production ensures high quality and consistency.

Notebooks, desktop computers, servers, graphic cards

Blue-ray disc recorders, set top box, Automotive systems.

Portable gaming devices, personal navigation systems, personal multimedia devices

Resistance to soldering heat Max three 40 second reflows at +260°C, parts cooled to room temperature between cycles

Moisture Sensitivity Level (MSL) 1 (unlimited floor life at <30°C / 85% relative humidity)

85% relative humidity)



★ When ordering, please check part number

Part Number	Inductance @1MHz,0.25V (uH)	DCR(Ω)		Isat (Max.) (A)		Irms (Max.) (A)	
		Max.	Typ.	Max.	Typ.	Max.	Typ.
ANR252012-R33N5.3A	0.33±30%	0.028	0.023	5.30	6.20	3.70	4.30
ANR252012-R47N4.9A	0.47±30%	0.035	0.029	4.90	5.60	3.45	4.00
ANR252012-R68N3.7A	0.68±30%	0.043	0.036	3.70	4.30	3.15	3.60
ANR252012-1R0M3.6A	1.0±20%	0.054	0.048	3.60	4.20	3.00	3.4
ANR252012-1R5M2.9A	1.5±20%	0.104	0.080	2.90	3.50	2.40	2.8
ANR252012-2R2M2.6A	2.2±20%	0.120	0.100	2.60	3.00	1.90	2.15
ANR252012-3R3M1.7A	3.3±20%	0.163	0.136	1.70	2.10	1.80	2.05
ANR252012-4R7M1.6A	4.7±20%	0.260	0.225	1.60	1.90	1.25	1.45
ANR252012-6R8M1.15A	6.8±20%	0.366	0.305	1.15	1.35	0.95	1.1
ANR252012-100M1.1A	10±20%	0.480	0.435	1.10	1.35	0.85	1.00
ANR252012-220M0.59A	22±20%	1.430	1.100	0.59	0.70	0.48	0.60

1. Isat: DC current at which the inductance drops approximate 30% from its value without current;

2. Irms: DC current that causes the temperature rise ($\Delta T = 40^\circ\text{C}$) from 25°C ambient;

3. Operating Temperature : $-40^\circ\text{C} \sim +125^\circ\text{C}$;

4. Absolute maximum voltage: DC 25V

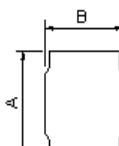


Fig 1

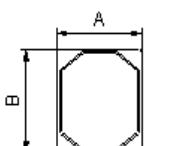
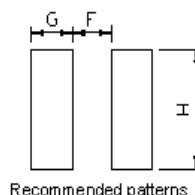


Fig 2



Recommended patterns

Dimensions

A	2.50±0.3
B	2.00±0.3
C	1.25 max
D	0.80±0.2
E	0.80±0.2
F	0.60 typ
G	1.00 typ
H	2.20 typ

Fig 1

unit : mm

Impedance/Inductance/Q/

LCR Agilent E4991A

Resistance DC

Chroma 16502

Current per winding that causes a 20°C rise from 25°C ambient

Electrical specifications at 25°C

Weight 23~30 mg

Packaging 2000/7" reel; Plastic tape: 8 mm wide.

Packaging will different, according the various chip size.

Contact Us

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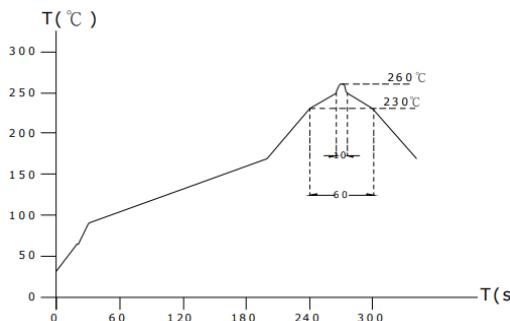
Official Website :

<https://www.bing-ri.com.tw/>

GENERAL CHARACTERISTICS

1. Operating temperature range: -40 TO +125°C (Includes temperature when the coil is heated)
2. External appearance: On visual inspection, the coil has no external defects.
3. Terminal strength: After soldering. Between copper plate and terminals of coil. Push in two directions of X.Ywithstanding at below conditions.
Terminal should not peel off. (refer to figure at right) 0.5kg Min -25201
4. Insulating resistance: Over 100MΩ at 100V D.C. between coil and core
5. Dielectric strength: No dielectric breakdown at 100V D.C. for 1 minute between coil and core
6. Temperature characteristics: Inductance coefficient $(0\sim 2,000)\times 10^{-6}$ / (°C -25~+80) . °C , inductance deviation within±5.0%, after 96 hours.
7. Humidity characteristics(Moisture Resistance): Inductance deviation within ±5%, after 96 hours in 90~95% relative humidity at 40 ±2 and 1 hour drying under normal condition.
8. Vibration resistance: Inductance deviation within ±5%, after vibration for 1 hour. In each of three orientations at sweep vibration (10~55~10 Hz) with 1.5mm P-P amplitudes.
9. Shock resistance: Inductance deviation within ±5%, after being dropped once with 981m/s² (100G) shock attitude upon a rubber block method shock testing machine, in three different
10. Resistance to Soldering Heat: 260 , 10 seconds(See attached recommend reflow)
11. Storage environment: Storage condition: Temperature Range: 10 ~ 35 (Generally: 21 ~ 31) , Humidity Range: 50% ~ 80% RH (Generally: 65% ~ 75%) ; Transportation condition: Temperature Range:-35 ~ 85 , Humidity Range: 50% ~ 95% RH
12. Use components within 12 months. If 12 months or more have elapsed, check soldarability before use.
13. Reflow profile recommend:

Lead-free heat en duran ce test



Lead-free the recommended reflow condition

